# Flexible Termination System (FT-CAP) X7R Dielectric, 6.3 – 250 VDC (Automotive Grade)



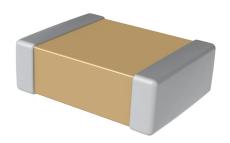
#### **Overview**

KEMET's Automotive Grade Flexible Termination (FT-CAP) multilayer ceramic capacitor in X7R dielectric incorporates a unique, flexible termination system that is integrated with KEMET's standard termination materials. A conductive silver epoxy is utilized between the base metal and nickel barrier layers of KEMET's standard termination system in order to establish pliability while maintaining terminal strength, solderability and electrical performance. This technology was developed in order to address the primary failure mode of MLCCs— flex cracks, which are typically the result of excessive tensile and shear stresses produced during board flexure and thermal cycling. Flexible termination technology inhibits the transfer of board stress to the rigid ceramic body, therefore mitigating flex cracks which can result in low IR or short circuit failures.

Although this technology does not eliminate the potential for mechanical damage that may propagate during extreme environmental and handling conditions, it does provide superior flex performance over standard termination systems. FT-CAP complements KEMET's Open Mode, Floating Electrode (FE-CAP), Floating Electrode with Flexible Termination (FF-CAP) and KEMET Power Solutions (KPS) product lines by providing a complete portfolio of flex mitigation solutions.

Combined with the stability of an X7R dielectric and designed to accommodate all capacitance requirements, these flex-robust devices are RoHS-compliant, offer up to 5mm of flex-bend capability and exhibit a predictable change in capacitance with respect to time and voltage. Capacitance change with reference to ambient temperature is limited to  $\pm 15\%$  from  $-55^{\circ}$ C to  $\pm 125^{\circ}$ C.

Whether under-hood or in-cabin, these capacitors are designed to provide reliable performance in mission and safety critical automotive circuits. Stricter testing protocol and inspection criteria have been established for automotive grade products in recognition of potentially harsh environmental conditions. KEMET automotive grade series capacitors meet the demanding Automotive Electronics Council's AEC-Q200 qualification requirements.



## **Ordering Information**

C	1206	X	106	K	4	R	Α	С	AUTO
Ceramic	Case Size (L" x W")	Specification/ Series	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VDC)	Dielectric	Failure Rate/ Design	Termination Finish <sup>1</sup>	Packaging/ Grade (C-Spec) <sup>2</sup>
	0603 0805 1206 1210 1808 1812 1825 2220 2225	X = Flexible Termination	Two significant digits and number of zeros	J = ±5% K = ±10% M = ±20%	9 = 6.3 8 = 10 4 = 16 3 = 25 5 = 50 1 = 100 2 = 200 A = 250	R = X7R	A = N/A	C = 100% Matte Sn	See "Packaging C-Spec Ordering Options Table" below

<sup>&</sup>lt;sup>1</sup> Additional termination finish options may be available. Contact KEMET for details.



## **Packaging C-Spec Ordering Options Table**

Packaging Type <sup>1</sup>	Packaging/Grade Ordering Code (C-Spec) <sup>3</sup>
7" Reel	AUT0
13" Reel/Unmarked	AUTO7411 (EIA 0603 and smaller case sizes) AUTO7210 (EIA 0805 and larger case sizes)
7" Reel/Unmarked/2 mm pitch²	3190
13" Reel/Unmarked/2 mm pitch <sup>2</sup>	3191

<sup>&</sup>lt;sup>1</sup> Reeling tape options (Paper or Plastic) are dependent on capacitor case size (L" x W") and thickness dimension. See "Chip Thickness/Tape & Reel Packaging Quantities" and "Tape & Reel Packaging Information".

#### **Benefits**

- AEC-Q200 automotive qualified
- -55°C to +125°C operating temperature range
- Superior flex performance (up to 5 mm)
- · High capacitance flex mitigation
- · Lead (Pb)-free, RoHS and REACH compliant
- EIA 0603, 0805, 1206, 1210, 1808, 1812, 1825, 2220, and 2225 case sizes
- DC voltage ratings of 6.3 V, 10 V, 16 V, 25 V, 50 V, 100 V, 200 V, and 250 V
- Capacitance offerings ranging from 180 pF to 22 μF
- Available capacitance tolerances of ±5%, ±10% and ±20%
- · Non-polar device, minimizing installation concerns
- 100% pure matte tin-plated termination finish allowing for excellent solderability

## **Applications**

Typical applications include circuits with a direct battery or power source connection, critical and safety relevant circuits without (integrated) current limitation and any application that is subject to high levels of board flexure or temperature cycling. Examples include raw power input side filtering (power plane/bus), high current applications (automobile battery line) and circuits that cannot be fused to open. Markets include consumer, medical, industrial (power supply), automotive, aerospace and telecom.

<sup>&</sup>lt;sup>2</sup> The 2 mm pitch option allows for double the packaging quantity of capacitors on a given reel size. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".

<sup>&</sup>lt;sup>3</sup> All Automotive packaging C-Specs listed exclude the option to laser mark components. Please contact KEMET if you require a laser marked option. For more information see "Capacitor Marking".

<sup>&</sup>lt;sup>3</sup> For additional Information regarding "AUTO" C-Spec options, see "Automotive C-Spec Information".



## **Automotive C-Spec Information**

KEMET Automotive Grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. These products are supported by a Product Change Notification (PCN) and Production Part Approval Process warrant (PPAP).

Automotive products offered through our distribution channel have been assigned an inclusive ordering code C-Spec, "AUTO." This C-Spec was developed in order to better serve small and medium-sized companies that prefer an automotive grade component without the requirement to submit a customer Source Controlled Drawing (SCD) or specification for review by a KEMET engineering specialist. This C-Spec is therefore not intended for use by KEMET's OEM Automotive customers and are not granted the same "privileges" as other automotive C-Specs. Customer PCN approval and PPAP request levels are limited (see details below).

#### **Product Change Notification (PCN)**

The KEMET Product Change Notification system is used to communicate primarily the following types of changes:

- Product/process changes that affect product form, fit, function, and/or reliability
- · Changes in manufacturing site
- Product obsolescence

KEMET Automotive	Customer Notifica	tion due to:	Days prior to
C-Spec	Process/Product change	Obsolescence*	implementation
KEMET assigned <sup>1</sup>	Yes (with approval and sign off)	Yes	180 days minimum
AUT0	Yes (without approval)	Yes	90 days minimum

<sup>&</sup>lt;sup>1</sup> KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

#### **Production Part Approval Process (PPAP)**

The purpose of the Production Part Approval Process is:

- To ensure that supplier can meet the manufacturability and quality requirements for the purchased parts.
- To provide the evidence that all customer engineering design record and specification requirements are properly understood and fulfilled by the manufacturing organization.
- To demonstrate that the established manufacturing process has the potential to produce the part.

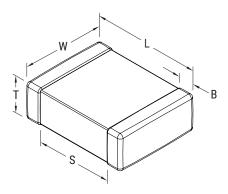
KEMET Automotive	I	PPAP (Product	Part Approval	Process) Leve	I
C-Spec	1	2	3	4	5
KEMET assigned <sup>1</sup>	•	•	•	•	•
AUT0	0		0		

<sup>&</sup>lt;sup>1</sup> KEMET assigned C-Specs require the submittal of a customer SCD or customer specification for review. For additional information contact KEMET.

- Part number specific PPAP available
- Product family PPAP only



## **Dimensions - Millimeters (Inches)**



EIA Size Code	Metric Size Code	L Length	W Width	T Thickness	B Bandwidth	S Separation Minimum	Mounting Technique
0603¹	1608	1.60 (0.063) ±0.17 (0.007)	0.80 (0.032) ±0.15 (0.006)		0.45 (0.018) ±0.15 (0.006)	0.58 (0.023)	0 - I W
0805 <sup>2</sup>	2012	2.00 (0.079) ±0.30 (0.012)	1.25 (0.049) ±0.30 (0.012)		0.50 (0.02) ±0.25 (0.010)	0.75 (0.030)	Solder Wave or Solder Reflow
1206	3216	3.30 (0.130) ±0.40 (0.016)	1.60 (0.063) ±0.35 (0.013)		0.60 (0.024) ±0.25 (0.010)		Solder Reliow
1210	3225	3.30 (.130) ±0.40 (.016)	2.60 (0.102) ±0.30 (0.012)		0.60 (0.024) ±0.25 (0.010)		
1808	4520	4.70 (0.185) ±0.50 (0.020)	2.00 (0.079) ±0.20 (0.008)	See Table 2 for Thickness	0.70 (0.028) ±0.35 (0.014)		
1812	4532	4.50 (0.178) ±0.40 (0.016)	3.20 (0.126) ±0.30 (0.012)	-	0.70 (0.028) ±0.35 (0.014)	N/A	Solder Reflow
1825	4564 5650	4.60 (0.181) ±0.40 (0.016)	6.40 (0.252) ±0.40 (0.016)	-	0.70 (0.028) ±0.35 (0.014)		Only
2220		5 90 (0 232) 5 00 (0 197)					
2225	5664	5.90 (0.232) ±0.75 (0.030)	6.40 (0.248) ±0.40 (0.016)	-	±0.35 (0.014) 0.70 (0.028) ±0.35 (0.014)		

<sup>&</sup>lt;sup>1</sup> For capacitance values ≥ 0.56 μF add 0.03 (0.001) to length tolerance dimension.

## **Qualification/Certification**

Automotive grade products meet or exceed the requirements outlined by the Automotive Electronics Council. Details regarding test methods and conditions are referenced in document AEC-Q200, Stress Test Qualification for Passive Components. For additional information regarding the Automotive Electronics Council and AEC-Q200, please visit their website at www.aecouncil.com.

## **Environmental Compliance**

Lead (Pb)-free, RoHS, and REACH compliant without exemptions.

 $<sup>^{2}</sup>$  For capacitance values ≥ 2.7 μF add 0.05 (0.002) to length tolerance dimension.



### **Electrical Parameters/Characteristics**

Item	Parameters/Characteristics
Operating Temperature Range	-55°C to +125°C
Capacitance Change with Reference to +25°C and 0 Vdc Applied (TCC)	±15%
<sup>1</sup> Aging Rate (Maximum % Capacitance Loss/Decade Hour)	3.0%
<sup>2</sup> Dielectric Withstanding Voltage (DWV)	250% of rated voltage (5±1 seconds and charge/discharge not exceeding 50mA)
<sup>3</sup> Dissipation Factor (DF) Maximum Limit at 25°C	See Dissipation Factor Limit Table
<sup>4</sup> Insulation Resistance (IR) Minimum Limit at 25°C	See Insulation Resistance Limit Table (Rated voltage applied for 120±5 seconds at 25°C)

<sup>&</sup>lt;sup>1</sup> 1Regarding Aging Rate: Capacitance measurements (including tolerance) are indexed to a referee time of 1,000 hours.

1kHz ± 50Hz and 1.0 ± 0.2 Vrms if capacitance ≤10μF

120Hz ± 10Hz and 0.5 ± 0.1 Vrms if capacitance >10μF

Note: When measuring capacitance it is important to ensure the set voltage level is held constant. The HP4284 and Agilent E4980 have a feature known as Automatic Level Control (ALC). The ALC feature should be switched to "ON".

<sup>&</sup>lt;sup>2</sup> DWV is the voltage a capacitor can withstand (survive) for a short period of time. It exceeds the nominal and continuous working voltage of the capacitor.

<sup>&</sup>lt;sup>3</sup> Capacitance and dissipation factor (DF) measured under the following conditions:

<sup>&</sup>lt;sup>4</sup> To obtain IR limit, divide  $M\Omega$ - $\mu$ F value by the capacitance and compare to  $G\Omega$  limit. Select the lower of the two limits.



## **Post Environmental Limits**

High '	Temperature	Life, Biased	Humidity, Mo	oisture Resis	tance
EIA Case Size	Rated DC Voltage	Capacitance	Dissipation Factor (Maximum %)	Capacitance Shift	Insulation Resistance
	< 16		7.5		
0603	16 / 25	< 1.0µF	5.0		
0003	> 25		3.0		
	All	≥ 1.0µF	20.0		
	< 16	< 4.7μF	7.5		
	< 10	≥ 4.7µF	20.0		
0005	10	< 4.7µF	5.0		
0805	16	≥ 4.7µF	20.0		
	25	All	5.0		
	> 25	All	3.0	±20%	10% of Initial Limit
	< 16	All	7.5		
1206¹	16 / 25	All	5.0		
	> 25	All	3.0		
	< 16	All	7.5		
1210	16 / 25	All	5.0		
	> 25	All	3.0		
	< 16	All	7.5		
1808 - 2225	16 / 25	All	5.0		
	> 25	All	3.0		

 $<sup>^{\</sup>rm 1}$  For Capacitance values 4.7  $\mu f$  and 10  $\mu F$  DF Post Value is 20% (All Voltages).



# **Insulation Resistance Limit Table (X7R Dielectric)**

EIA Case Size	1,000 Megohm Microfarads or 100 GΩ	500 Megohm Microfarads or 10 GΩ	100 Megohm Microfarads or 10 GΩ
0402	< 0.012 μF	≥ 0.012 µF	N/A
0603	< 0.047 μF	≥ 0.047 µf < 0.47 µf	≥ 0.47 µf
0805	< 0.15 μF	≥ 0.15 µF < 2.2 µf	≥ 2.2 µf
1206	< 0.47 μF	≥ 0.47 µF < 4.7 µf	≥ 4.7 µf
1210	< 0.39 μF	≥ 0.39 µF < 10 µf	≥ 10 µf
1808	ALL	N/A	N/A
1812	< 2.2 μF	≥ 2.2 µF	N/A
1825	ALL	N/A	N/A
2220	< 10 μF	≥ 10 µF	N/A
2225	ALL	N/A	N/A

# **Dissipation Factor (DF) Limit Table**

EIA Case Size	Rated DC Voltage	Capacitance	Dissipation Factor (Maximum %)
	< 16		5.0
0603	16/25	< 1.0µF	3.5
0003	> 25		2.5
	All	≥ 1.0µF	10.0
	< 16	< 4.7µF	5.0
	< 10	≥ 4.7µF	10.0
0805	16	< 4.7µF	3.5
0003	10	≥ 4.7µF	10.0
	25	All	3.5
	> 25	All	2.5
	< 16	All	5.0
1206¹	16/25	All	3.5
	> 25	All	2.5
	< 16	All	5.0
1210	16 / 25	All	3.5
	> 25	All	2.5
	< 16	All	5.0
1808 - 2225	16/25	All	3.5
	> 25	All	2.5

 $<sup>^{1}</sup>$  For Capacitance values 4.7  $\mu f$  and 10  $\mu F$  DF Value is 10% (All Voltages).



# Table 1A - Capacitance Range/Selection Waterfall (0603 - 1210 Case Sizes)

		Cas S	e Si erie				CO	)60	3X					(	<b>C08</b>	052	X					(	C12	062	<b>(</b>						C12	210)	(		
Сар	Cap	Volt	age C	ode	9	8	4	3	5	1	2	9	8	4	3	5	1	2	A	9	8	4	3	5	1	2	A	9	8	4	3	5	1	2	A
	Code		d Vol (VDC)		6.3	1	16	25	20	100	200	6.3	2	16	25	20	100	200	250	6.3	2	16	25	20	100	200	250	6.3	2	16	25	20	9	200	250
		Cap	Tolera	ance					Pı	odu	ct A	vaila	bilit	y an	d Ch	ip T	hick	ness	Cod	les -	See	Tab	le 2	for	Chip	Thi	ckne	ess C	ime	nsio	ns				
180 pF	181	J	K	M	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR																
220 pF 270 pF	221 271	J	K K	M	Cl	CJ	CJ	Cl	CJ	Cl	CJ	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR																
330 pF	331	J	K	М	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR																
390 pF 470 pF	391 471	J	K K	M	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR																
560 pF	561	J	K	М	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR	İ								l							İ
680 pF 820 pF	681 821	J	K K	M	Cl	CJ	CJ	CJ	CJ	CJ	Cl	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR																
1,000 pF	102	J	K	M	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR	EQ															
1,200 pF 1,500 pF	122 152	J J	K K	M M	Cl	CJ	CJ	CJ	CJ	CJ	CJ	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ								
1,800 pF	182	J	K	M	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR	EQ															
2,200 pF	222	J	K	М	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR	EQ	FN														
2,700 pF 3,300 pF	272 332	J	K K	M	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	EQ EQ	EQ EQ	EQ EQ	EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN
3,900 pF	392	J	K	М	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR	EQ	FN														
4,700 pF 5,600 pF	472 562	J	K K	M	Cl	CJ	CJ	CJ	CJ	CJ	CJ	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN
6,800 pF	682	J	K	M	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR	EQ	FN														
8,200 pF	822	J	K	М	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR	DR	DR	DR	DR	DR	DR	DR	EQ	FN														
10,000 pF 12,000 pF	103 123	J	K K	M	CJ	CJ	CJ	CJ	CJ	CJ	CJ	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	DR DR	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN
15,000 pF	153	J	K	М	CJ	CJ	CJ	CJ	CJ	CJ		DR	DR	DR	DR	DR	DD	DR	DR	EQ	FN														
18,000 pF 22,000 pF	183 223	J	K K	M	CJ	CJ	CJ	CJ	CJ	CJ		DR DR	DR DR	DR DR	DR DR	DR DR	DD DD	DR DR	DR DR	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	FN	FN	FN	FN	FN FN	FN FN	FN FN	FN FN
27,000 pF	273	J	K	M	CJ	CJ	CJ	CJ	CJ	CJ		DR	DR	DR	DR	DR	DD	DS	DK	EQ	FN														
33,000 pF	333	J	K	М	CJ	CJ	CJ	CJ	CJ	CJ		DR	DR	DR	DR	DR	DD	DS		EQ	FN														
39,000 pF 47,000 pF	393 473	J	K K	M	Cl	CJ	CJ	CJ	CJ	CJ		DR DR	DR DR	DR DR	DR DR	DR DR	DD DS	DS DG		EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	ER ER	EQ ES	EQ ES	FN FN	FN FN	FN FN	FN FN	FN FN	FN FN	FN FQ	FN FQ
56,000 pF	563	J	K	М	CJ	CJ	CJ	CJ	CJ			DD	DD	DD	DD	DD	DS	DG		EQ	EQ	EQ	EQ	EQ	EQ	ES	ES	FN	FN	FN	FN	FN	FN	FQ	FQ
68,000 pF 82,000 pF	683 823	J	K K	M	Cl	CJ	CJ	CJ	CJ			DD DD	DD DD	DD DD	DD DD	DD DD	DS DS			EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	EQ EQ	ES ES	ES ES	FN FN	FN FN	FN FN	FN FN	FN FN	FN FQ	FQ FA	FQ FA
0.10 μF	104	J	K	M	CJ	CJ	CJ	CJ	CJ			DR	DR	DR	DR	DR	DS			EQ	EQ	EQ	EQ	EQ	EQ	EM	EM	FN	FN	FN	FN	FN	FX	FZ	FZ
0.12 µF	124	J	K	М	CJ	CJ	CJ	CJ	CJ			DR	DR	DR	DR	DD	DG			ER	ER	ER	ER	ER	ER	EU		FN	FN	FN	FN	FN	FX	FU	FU
0.15 μF 0.18 μF	154 184	J	K K	M	Cl	CJ	CJ	CJ	CJ			DR DR	DR DR	DR DR	DR DR	DD DD	DG DG			ER ER	ER ER	ER ER	ER ER	ER ER	ER ER	EU		FQ FQ	FQ FQ	FQ FQ	FQ FQ	FQ FQ	FX FX	FM FK	FM   FK
0.22 μF	224	J	K	М	CJ	CJ	CJ	CJ				DR	DR	DR	DR	DD	DG			ER	ER	ER	ER	ER	ER			FQ	FQ	FQ	FQ	FQ	FX	FK	FK
0.27 μF 0.33 μF	274 334	J	K K	M	CJ	CJ	CJ					DD DD	DD DD	DD DD	DD DD	DD DD				EQ EQ	EQ EQ	EQ EQ	EQ EQ	ER ER	EU			FQ FX	FQ FX	FQ FX	FQ FX	FQ FX	FX FX		
0.33 μF 0.39 μF	394	J	K	M	CJ	CJ	CJ					DG	DG	DG	DG	DS				EQ	EQ	EQ	EQ	ER	EU			FX	FX	FX	FX	FX	FX		
0.47 µF	474	J	K	M	CJ	CJ	CJ					DD	DD	DD	DD	DS				ER	ER	ER	ER	ER	EU			FX	FX	FX	FX	FX	FX		
0.56 μF 0.68 μF	564 684	J	K K	M								DD DD	DD DD	DD DD	DG DG	DH				ES ET	ES ET	ES ET	ES ET	ER ES	EM EM			FX FX	FX FX	FX FX	FX FX	FX FX	FA FZ		
0.82 μF	824	J	K	М								DD	DD	DD	DG					EF	EF	EF	EF	ES	EH			FA	FA	FA	FA	FA	FL		
1.0 μF 1.2 μF	105 125	J J	K K	M								DD DS	DD DS	DD DS	DG					EF ES	EF ES	EF ES	EU	ES EH	EH			FU FU	FU FU	FU FU	FU FU	FU FZ	FM FH		
1.5 μF	155	J	K	M								DG	DG	DG						ES	ES	ES	EU	EH				FU	FU	FU	FU	FZ	FM		
1.8 µF	185	J	K	M								DG	DG DG							ES ES	ES	ES	EF	EH EH				FU FJ	FU FJ	FU	FU	FZ	FJ FK		
2.2 μF 2.7 μF	225 275	J	K K	M								טט	טט	טט						EN	ES EN	ES EN	EF EH	сп				FE	FE	FJ FE	FJ FZ	FZ FU	гĸ		
3.3 μF	335	J	K	М								1								ES	ES	ES	EH					FA	FA	FA	FM	FM			
3.9 μF 4.7 μF	395 475	J	K K	M								DH	DH	DH						EF EF	EF EA	EF EA	EH					FZ FQ	FZ FQ	FZ FQ		FK FS			
5.6 μF	565	J	K	М								[									EH	EH						FA	FA	FA	FU				
	Can		d Vol (VDC)		6.3	2	9	25	20	100	200	6.3	2	16	25	20	100	200	250	6.3	1	16	25	20	100	200	250	6.3	2	16	25	20	5	200	250
Сар	Cap Code		age C		9	8	4	3	5	1	2	9	8	4	3	5	1	2	A	9	8	4	3	5	1	2	A	9	8	4	3	5	1	2	Α
			se Si Serie				С	0603	3X						C08	05X							C12	06X							C12	10X			



## Table 1A - Capacitance Range/Selection Waterfall (0603 - 1210 Case Sizes) cont'd

			se S erie	ize/ es			CO	60	3X					(	208	05)	<b>(</b>					(	C12	062	K					(	C12	10)	(		
Сар	Cap		tage (	ode	9	8	4	3	5	1	2	9	8	4	3	5	1	2	Α	9	8	4	3	5	1	2	Α	9	8	4	3	5	1	2	Α
oup	Code	Nacc	ed Vol		6.3	10	16	25	20	100	200	6.3	10	16	25	20	100	200	250	6.3	10	16	25	20	100	200	250	6.3	10	16	25	20	100	200	250
		Сар	Toler	ance					Pı	odu	ct A	vaila	bilit	y an	d Ch	ip Tl	nick	ness	Cod	les -	See	Tab	le 2	for	Chip	Thi	ckne	ss D	ime	nsio	ns				
6.8 µF	685	J	K	М																EH	EH	EH						FZ	FZ	FZ	FM				
8.2 µF	825	J	K	М	l							l								EH	EH	EH						FU	FU	FU	FK				
10 μF	106	J	K	М	l							DH	DH							EΑ	EA	EA	EA					FU	FU	FU	FS				
12 μF	126	J	K	М	l							l								l								l							
15 μF	156	J	K	М	l							l								l								l							
18 μF	186	J	K	М																															
22 μF	226	J	K	М																								FS	FS						
			d Vol	•	6.3	10	16	25	20	100	200	6.3	10	16	25	50	100	200	250	6.3	10	16	25	20	100	200	250	6.3	10	16	25	50	100	200	250
Cap	Cap Code	Volt	tage (	ode	9	8	4	3	5	1	2	9	8	4	3	5	1	2	Α	9	8	4	3	5	1	2	Α	9	8	4	3	5	1	2	Α
	Joue	Case Size/ Series				C0603X									C08	05X							C12	06X							C12	10X			

# Table 1B - Capacitance Range/Selection Waterfall (1808 - 2225 Case Sizes)

			e S erie	ize/ es		C18	08X			С	1812	X			C18	25X			C	2220	X			C22	25X	
Cap	Cap	Volt	age (	Code	5	1	2	Α	3	5	1	2	Α	5	1	2	Α	3	5	1	2	Α	5	1	2	Α
oup	Code		d Vol	ltage	50	100	200	250	25	50	100	200	250	50	100	200	250	25	20	100	200	250	20	100	200	250
		-	Toler			1			ı uct Av	ailabi	litv an	d Chir	l .	kness	Code		l	e 2 foi	r Chip	Thick	l		sions			
4,700 pF	472	J	К	М	LD	LD	LD				,															
5,600 pF	562	Ĵ	K	М	LD	LD	LD																			
6,800 pF	682	J	K	М	LD	LD	LD		GB	GB	GB	GB	GB													
8,200 pF	822	J	K	М	LD	LD	LD		GB	GB	GB	GB	GB													
10,000 pF	103	J	K	M	LD	LD	LD		GB	GB	GB	GB	GB													
12,000 pF	123	J	K	M	LD	LD	LD		GB	GB	GB	GB	GB													
15,000 pF	153	J	K	M	LD	LD	LD		GB	GB	GB	GB	GB													
18,000 pF	183	J	K	M	LD	LD	LD		GB	GB	GB	GB	GB													
22,000 pF	223	J	K	M	LD	LD			GB	GB	GB	GB	GB	НВ	HB	HB	HB									
27,000 pF	273	J	K	M	LD	LD			GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ									
33,000 pF	333	J	K	M	LD	LD			GB	GB	GB	GB	GB	НВ	НВ	HB	НВ									
39,000 pF	393	J	K	M	LD	LD			GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ									
47,000 pF	473	J	K	M	LD	LD			GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ									
56,000 pF	563	J	K	M	LD	LD			GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ									
68,000 pF	683	J	K	M	LD				GB	GB	GB	GB	GB	НВ	НВ	НВ	НВ		10							
82,000 pF	823	J	K	M	LD				GB	GB	GB	GB	GB	HB	HB	НВ	HB	JC	JC	JC	JC	JC				
0.10 μF	104	J	K	M	LD				GB	GB	GB	GB	GB	HB	HB	HB	HB	JC	JC	JC	JC	JC	KC	KC	KC	KC
0.12 μF	124	J	K	M	LD				GB	GB	GB	GB	GB	НВ	HB	HB	HB	JC	JC	JC	JC	JC	KC	KC	KC	KC
0.15 µF	154	J	K	M	LD				GB	GB	GB	GE	GE	НВ	HB	HB	HB	JC	JC	JC	JC	JC	KC	KC	KC	KC
0.18 µF	184 224	J	K	M	LD				GB GB	GB GB	GB GB	GF GG	GG GG	HB HB	HB HB	HB HB	HB HB	JC	JC	JC	JC JC	JC	KC KC	KC KC	KC KC	KC KC
0.22 μF 0.27 μF	274	J	K	M					GB	GB	GG	GG	GG	нв НВ	НВ	НВ	НВ	JC JC	JC	JC	JC	JC	KB	KC	KC	KC
0.27 μF 0.33 μF	334	J	K	M					GB	GB	GG	GG	GG	нв НВ	НВ	НВ	НВ	JC	JC	JC	JC	JC	KB	KC	KC	KC
0.33 μF 0.39 μF	394	J	K	M					GB	GB	GG	GG	GG	НВ	НВ	HD	HD	JC	JC	JC	JC	JC	KB	KC	KC	KC
0.39 μF 0.47 μF	474	J	K	M					GB	GB	GG	GJ	GJ	НВ	НВ	HD	HD	JC	JC	JC	JC	JC	KB	KC	KD	KD
0.47 μF 0.56 μF	564	J	K	M					GC	GC	GG	00	00	HB	HD	HD	HD	JC	JC	JC	JD	JD	KB	KC	KD	KD
0.68 μF	684	J	K	M					GC	GC	GG			HB	HD	HD	HD	JC	JC	JD	JD	JD	KB	KC	KD	KD
0.82 uF	824	Ĵ	K	M					GE	GE	GG			НВ	HF	HF	HF	JC	JC	JF	JF	JF	КВ	KC	KE	KE
1.0 μF	105	Ĵ	K	M					GE	GE	GG			НВ	HF	HF	HF	JC	JC	JF	JF	JF	КВ	KD	KE	KE
1.2 µF	125	Ĵ	K	M					GB	GB	GB			НВ				JC	JC		•		KB	KE	KE	KE
-	<u> </u>		d Vo		20	100	200	250	25	20	001	200	250	20	9	200	250	25	20	100	200	250	20	100	200	20
	Cap	-	(VDC			5 1 2 A					-				· ·	1				-						2
Cap	Code	<u> </u>	age (		5	1	2	A	3	5	1	2	Α	5	1	2	A	3	5	1	2	A	5	1	2	Α
		Case Size/ Series			C1808X				C1812X						C18	25X				2220	X			C22	25X	



# Table 1B - Capacitance Range/Selection Waterfall (1808 - 2225 Case Sizes) cont'd

			se S Serie	ize/ es		C18	08X			С	1812	2X			C18	25X			С	2220	X			C22	25X	
Cap	Cap	Vol	tage (	Code	5	1	2	Α	3	5	1	2	A	5	1	2	Α	3	5	1	2	Α	5	1	2	Α
Oup	Code	Rat	ed Vo (VDC		20	100	200	250	25	20	100	200	250	20	100	200	250	25	20	100	200	250	20	100	200	250
		Cap	Toler	ance				Prod	uct Av	ailabi	lity an	d Chi <sub>l</sub>	Thic	kness	Code	s – Se	e Tabl	e 2 fo	r Chip	Thick	ness	Dimen	sions			
1.5 µF	155	J	K	М					GC	GC	GC			НС				JC	JC				KC			
1.8 µF	185	J	K	M					GE	GE	GE			HD				JD	JD				KD			
2.2 μF	225	J	K	M					GG	GG	GG			HF				JF	JF				KD			
2.7 μF	275	J	K	M					GJ	GJ	GJ															
3.3 µF	335	J	K	M					GL	GL	GL															
3.9 µF	395	J	K	M																						
4.7 μF	475	J	K	M					GK	GK																
5.6 µF	565	J	K	М																						
6.8 µF	685	J	K	М																						
8.2 µF	825	J	K	М																						
10 μF	106	l J	K	M					GK									JF	J0							
12 μF	126	J	K	М																						
15 μF	156	J	K	M														J0								
18 μF 22 μF	186 226	J	K	M M														JO								
ΖΖ μΓ	220	Dat	ed Vo																							
		""	(VDC	•	20	100	200	250	25	50	100	200	250	20	100	200	250	25	20	100	200	250	20	100	200	250
Сар	Cap	Vol	tage (	Code	5	1	2	Α	3	5	1	2	Α	5	1	2	Α	3	5	1	2	Α	5	1	2	Α
	Code	Case Size/ Series			C18	08X			(	1812	x			C18	25X			(	2220	X			C22	25X		



Table 2 - Chip Thickness/Tape & Reel Packaging Quantities

Thickness	Case	Thickness ±	Paper Q	uantity <sup>1</sup>	Plastic (	Quantity	
Code	Size <sup>1</sup>	Range (mm)	7" Reel	13" Reel	7" Reel	13" Reel	
CJ	0603	0.80 ± 0.15*	4,000	15,000	0	0	
DR	0805	0.78 ± 0.20	0	0	4,000	10,000	
DD	0805	0.90 ± 0.10	0	0	4,000	10,000	
DS	0805	1.00 ± 0.20	0	0	2,500	10,000	
DG	0805	1.25 ± 0.15	0	0	2,500	10,000	
DH	0805	1.25 ± 0.20	0	0	2,500	10,000	
EQ	1206	0.78 ± 0.20	4,000	10,000	4,000	10,000	
ER	1206	0.90 ± 0.20	0	0	4,000	10,000	
EN ES	1206 1206	0.95 ± 0.10	0	0	4,000 2,500	10,000	
ET	1206	1.00 ± 0.20 1.10 ± 0.20	0	0	2,500	10,000 10,000	
EF	1206	1.10 ± 0.20 1.20 ± 0.15	0	0	2,500	10,000	
EM	1206	1.25 ± 0.15	0	0	2,500	10,000	
EH	1206	1.60 ± 0.20	0	0	2,000	8,000	
EU	1206	1.60 ± 0.25	0	0	2,000	8,000	
EA	1206	1.60 ± 0.25	0	0	2,000	8,000	
FN	1210	0.78 ± 0.20	0	0	4,000	10,000	
FQ	1210	0.90 ± 0.20	Ő	Ő	4,000	10,000	
FX	1210	0.95 ± 0.20	0	0	4,000	10,000	
FE	1210	1.00 ± 0.10	Ö	Ö	2,500	10,000	
FA	1210	1.10 ± 0.15	0	0	2,500	10,000	
FZ	1210	1.25 ± 0.20	0	0	2,500	10,000	
FL	1210	1.40 ± 0.15	Ö	0	2,000	8,000	
FH	1210	1.55 ± 0.15	0	0	2,000	8,000	
FU	1210	1.55 ± 0.20	0	0	2,000	8,000	
FM	1210	1.70 ± 0.20	0	0	2,000	8,000	
FJ	1210	1.85 ± 0.20	0	0	2,000	8,000	
FK	1210	2.10 ± 0.20	0	0	2,000	8,000	
FS	1210	2.50 ± 0.30	0	0	1,000	4,000	
LD	1808	0.90 ± 0.10	0	0	2,500	10,000	
GB	1812	1.00 ± 0.10	0	0	1,000	4,000	
GC	1812	1.10 ± 0.10	0	0	1,000	4,000	
GE	1812	1.30 ± 0.10	0	0	1,000	4,000	
GF	1812	1.50 ± 0.10	0	0	1,000	4,000	
GG	1812	1.55 ± 0.10	0	0	1,000	4,000	
GK	1812	1.60 ± 0.20	0	0	1,000	4,000	
GJ	1812	1.70 ± 0.15	0	0	1,000	4,000	
GL	1812	1.90 ± 0.20	0	0	500	2,000	
HB	1825	1.10 ± 0.15	0	0	1,000	4,000	
HC	1825	1.15 ± 0.15	0	0	1,000	4,000	
HD	1825	1.30 ± 0.15	0	0	1,000	4,000	
HF	1825	1.50 ± 0.15	0	0	1,000	4,000	
JC	2220	1.10 ± 0.15	0	0	1,000	4,000	
JD JF	2220 2220	1.30 ± 0.15	0 0	0	1,000 1,000	4,000 4,000	
J0	2220	1.50 ± 0.15 2.40 ± 0.15	0	0	500	2,000	
KB	2225	1.00 ± 0.15	0	0	1,000	4,000	
KC	2225	1.10 ± 0.15 1.10 ± 0.15	0	0	1,000	4,000	
KD KD	2225	1.30 ± 0.15	0	0	1,000	4,000	
KE	2225	1.40 ± 0.15	0	0	1,000	4,000	
Thickness	Case	Thickness ±	7" Reel	13" Reel	7" Reel	13" Reel	
Code	Size1	Range (mm)	Paper Q	uantity <sup>1</sup>	Plastic Quantity		

Package quantity based on finished chip thickness specifications.

<sup>&</sup>lt;sup>1</sup> If ordering using the 2 mm Tape and Reel pitch option, the packaging quantity outlined in the table above will be doubled. This option is limited to EIA 0603 (1608 metric) case size devices. For more information regarding 2 mm pitch option see "Tape & Reel Packaging Information".

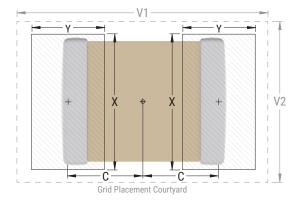


Table 3 - Chip Capacitor Land Pattern Design Recommendations per IPC-7351

EIA Size Code	Metric Size Code	Density Level A: Maximum (Most) Land Protrusion (mm)				Density Level B: Median (Nominal) Land Protrusion (mm)					Density Level C: Minimum (Least) Land Protrusion (mm)					
Code	Code	С	Y	X	V1	V2	С	Y	X	V1	V2	С	Y	X	V1	V2
0603	1608	0.85	1.25	1.10	4.00	2.10	0.75	1.05	1.00	3.10	1.50	0.65	0.85	0.90	2.40	1.20
0805	2012	0.99	1.44	1.66	4.47	2.71	0.89	1.24	1.56	3.57	2.11	0.79	1.04	1.46	2.42	1.81
1206	3216	1.59	1.62	2.06	5.85	3.06	1.49	1.42	1.96	4.95	2.46	1.39	1.22	1.86	4.25	2.16
1210	3225	1.59	1.62	3.01	5.90	4.01	1.49	1.42	2.91	4.95	3.41	1.39	1.22	2.81	4.25	3.11
1808	4520	2.30	1.75	2.30	7.40	3.30	2.20	1.55	2.20	6.50	2.70	2.10	1.35	2.10	5.80	2.40
1812	4532	2.10	1.80	3.60	7.00	4.60	2.00	1.60	3.50	6.10	4.00	1.90	1.40	3.40	5.40	3.70
1825	4564	2.15	1.80	6.90	7.10	7.90	2.05	1.60	6.80	6.20	7.30	1.95	1.40	6.70	5.50	7.00
2220	5650	2.85	2.10	5.50	8.80	6.50	2.75	1.90	5.40	7.90	5.90	2.65	1.70	5.30	7.20	5.60
2225	5664	2.85	2.10	6.90	8.80	7.90	2.75	1.90	6.80	7.90	7.30	2.65	1.70	6.70	7.20	7.00

Density Level A: For low-density product applications. Recommended for wave solder applications and provides a wider process window for reflow solder processes. KEMET only recommends wave soldering of EIA 0603, 0805, and 1206 case sizes.

Density Level B: For products with a moderate level of component density. Provides a robust solder attachment condition for reflow solder processes. Density Level C: For high component density product applications. Before adapting the minimum land pattern variations the user should perform qualification testing based on the conditions outlined in IPC Standard 7351 (IPC-7351). Image below based on Density Level B for an EIA 1210 case size.





## **Soldering Process**

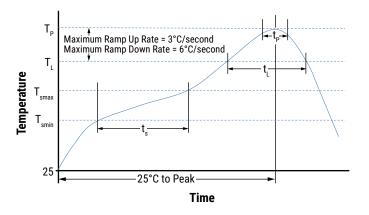
#### **Recommended Soldering Technique:**

- Solder wave or solder reflow for EIA case sizes 0603, 0805 and 1206
- · All other EIA case sizes are limited to solder reflow only

#### **Recommended Reflow Soldering Profile:**

KEMET's families of surface mount multilayer ceramic capacitors (SMD MLCCs) are compatible with wave (single or dual), convection, IR or vapor phase reflow techniques. Preheating of these components is recommended to avoid extreme thermal stress. KEMET's recommended profile conditions for convection and IR reflow reflect the profile conditions of the IPC/ J-STD-020 standard for moisture sensitivity testing. These devices can safely withstand a maximum of three reflow passes at these conditions.

Profile Feature	Terminati	ion Finish
Fibilie i catule	SnPb	100% Matte Sn
Preheat/Soak		
Temperature Minimum (T <sub>Smin</sub> )	100°C	150°C
Temperature Maximum $(T_{Smax})$	150°C	200°C
Time ( $t_s$ ) from $T_{smin}$ to $T_{smax}$	60 - 120 seconds	60 - 120 seconds
Ramp-Up Rate $(T_L \text{ to } T_p)$	3°C/second maximum	3°C/second maximum
Liquidous Temperature (T <sub>L</sub> )	183°C	217°C
Time Above Liquidous (t <sub>L</sub> )	60 - 150 seconds	60 - 150 seconds
Peak Temperature (T <sub>P</sub> )	235°C	260°C
Time Within 5°C of Maximum Peak Temperature (t <sub>p</sub> )	20 seconds maximum	30 seconds maximum
Ramp-Down Rate (T <sub>p</sub> to T <sub>L</sub> )	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum



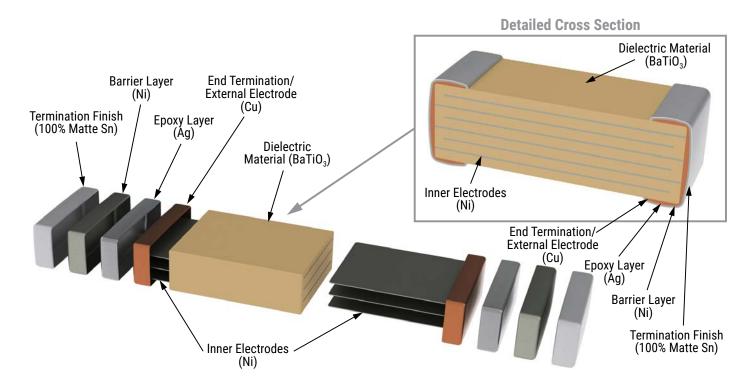
Note 1: All temperatures refer to the center of the package, measured on the capacitor body surface that is facing up during assembly reflow.

# **Storage and Handling**

Ceramic chip capacitors should be stored in normal working environments. While the chips themselves are quite robust in other environments, solderability will be degraded by exposure to high temperatures, high humidity, corrosive atmospheres, and long term storage. In addition, packaging materials will be degraded by high temperature—reels may soften or warp and tape peel force may increase. KEMET recommends that maximum storage temperature not exceed 40°C and maximum storage humidity not exceed 70% relative humidity. Temperature fluctuations should be minimized to avoid condensation on the parts and atmospheres should be free of chlorine and sulfur bearing compounds. For optimized solderability chip stock should be used promptly, preferably within 1.5 years of receipt.



## **Construction**





## **Capacitor Marking (Optional):**

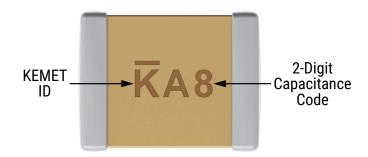
These surface mount multilayer ceramic capacitors are normally supplied unmarked. If required, they can be marked as an extra cost option. Marking is available on most KEMET devices but must be requested using the correct ordering code identifier(s). If this option is requested, two sides of the ceramic body will be laser marked with a "K" to identify KEMET, followed by two characters (per EIA-198 - see table below) to identify the capacitance value. EIA 0603 case size devices are limited to the "K" character only.

Laser marking option is <u>not</u> available on:

- · COG, Ultra Stable X8R and Y5V dielectric devices.
- EIA 0402 case size devices.
- EIA 0603 case size devices with Flexible Termination option.
- KPS Commercial and Automotive Grade stacked devices.
- · X7R dielectric products in capacitance values outlined below.

<b>EIA Case Size</b>	<b>Metric Size Code</b>	Capacitance
0603	1608	≤ 170 pF
0805	2012	≤ 150 pF
1206	3216	≤ 910 pF
1210	3225	≤ 2,000 pF
1808	4520	≤ 3,900 pF
1812	4532	≤ 6,700 pF
1825	4564	≤ 0.018 µF
2220	5650	≤ 0.027 µF
2225	5664	≤ 0.033 µF

Marking appears in legible contrast. Illustrated below is an example of an MLCC with laser marking of "KA8", which designates a KEMET device with rated capacitance of 100 µF. Orientation of marking is vendor optional.





# **Capacitor Marking (Optional) cont'd**

	C	apacita	nce (pl	F) For \	/arious	Alpha/	Numera	al Identif	iers	
Alpha						Numera	ıl			
Alpha Character	9	0	1	2	3	4	5	6	7	8
Cilaracter					Capa	citance	e (pF)			
Α	0.10	1.0	10	100	1,000	10,000	100,000	1,000,000	10,000,000	100,000,000
В	0.11	1.1	11	110	1,100	11,000	110,000	1,100,000	11,000,000	110,000,000
С	0.12	1.2	12	120	1,200	12,000	120,000	1,200,000	12,000,000	120,000,000
D	0.13	1.3	13	130	1,300	13,000	130,000	1,300,000	13,000,000	130,000,000
Е	0.15	1.5	15	150	1,500	15,000	150,000	1,500,000	15,000,000	150,000,000
F	0.16	1.6	16	160	1,600	16,000	160,000	1,600,000	16,000,000	160,000,000
G	0.18	1.8	18	180	1,800	18,000	180,000	1,800,000	18,000,000	180,000,000
Н	0.20	2.0	20	200	2,000	20,000	200,000	2,000,000	20,000,000	200,000,000
J	0.22	2.2	22	220	2,200	22,000	220,000	2,200,000	22,000,000	220,000,000
K	0.24	2.4	24	240	2,400	24,000	240,000	2,400,000	24,000,000	240,000,000
L	0.27	2.7	27	270	2,700	27,000	270,000	2,700,000	27,000,000	270,000,000
М	0.30	3.0	30	300	3,000	30,000	300,000	3,000,000	30,000,000	300,000,000
N	0.33	3.3	33	330	3,300	33,000	330,000	3,300,000	33,000,000	330,000,000
Р	0.36	3.6	36	360	3,600	36,000	360,000	3,600,000	36,000,000	360,000,000
Q	0.39	3.9	39	390	3,900	39,000	390,000	3,900,000	39,000,000	390,000,000
R	0.43	4.3	43	430	4,300	43,000	430,000	4,300,000	43,000,000	430,000,000
S	0.47	4.7	47	470	4,700	47,000	470,000	4,700,000	47,000,000	470,000,000
T	0.51	5.1	51	510	5,100	51,000	510,000	5,100,000	51,000,000	510,000,000
U	0.56	5.6	56	560	5,600	56,000	560,000	5,600,000	56,000,000	560,000,000
V	0.62	6.2	62	620	6,200	62,000	620,000	6,200,000	62,000,000	620,000,000
W	0.68	6.8	68	680	6,800	68,000	680,000	6,800,000	68,000,000	680,000,000
Х	0.75	7.5	75	750	7,500	75,000	750,000	7,500,000	75,000,000	750,000,000
Υ	0.82	8.2	82	820	8,200	82,000	820,000	8,200,000	82,000,000	820,000,000
Z	0.91	9.1	91	910	9,100	91,000	910,000	9,100,000	91,000,000	910,000,000
а	0.25	2.5	25	250	2,500	25,000	250,000	2,500,000	25,000,000	250,000,000
b	0.35	3.5	35	350	3,500	35,000	350,000	3,500,000	35,000,000	350,000,000
d	0.40	4.0	40	400	4,000	40,000	400,000	4,000,000	40,000,000	400,000,000
е	0.45	4.5	45	450	4,500	45,000	450,000	4,500,000	45,000,000	450,000,000
f	0.50	5.0	50	500	5,000	50,000	500,000	5,000,000	50,000,000	500,000,000
m	0.60	6.0	60	600	6,000	60,000	600,000	6,000,000	60,000,000	600,000,000
n	0.70	7.0	70	700	7,000	70,000	700,000	7,000,000	70,000,000	700,000,000
t	0.80	8.0	80	800	8,000	80,000	800,000	8,000,000	80,000,000	800,000,000
у	0.90	9.0	90	900	9,000	90,000	900,000	9,000,000	90,000,000	900,000,000



## **Tape & Reel Packaging Information**

KEMET offers multilayer ceramic chip capacitors packaged in 8, 12 and 16 mm tape on 7" and 13" reels in accordance with EIA Standard 481. This packaging system is compatible with all tape-fed automatic pick and place systems. See Table 2 for details on reeling quantities for commercial chips.

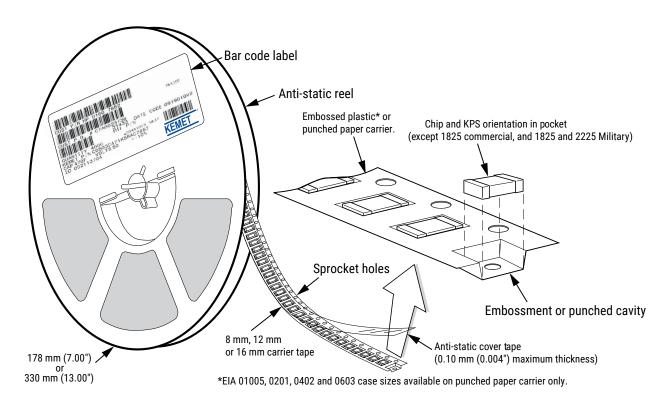


Table 5 - Carrier Tape Configuration, Embossed Plastic & Punched Paper (mm)

	Tape	Embosse	ed Plastic	Punche	d Paper
<b>EIA Case Size</b>	Size	7" Reel	13" Reel	7" Reel	13" Reel
	(W)*	Pitch	(P <sub>1</sub> )*	Pitch	(P <sub>1</sub> )*
01005 - 0402	8			2	2
0603	8			2/4	2/4 -
0805	8	4	4	4	4
1206 - 1210	8	4	4	4	4
1805 - 1808	12	4	4		
≥ 1812	12	8	8		
KPS 1210	12	8	8		
KPS 1812 and 2220	16	12	12		
Array 0612	8	4	4		

<sup>\*</sup>Refer to Figures 1 and 2 for W and  $P_1$  carrier tape reference locations.

#### **New 2 mm Pitch Reel Options\***

	Packaging Ordering Code (C-Spec)	Packaging Type/Options
•	C-3190	Automotive grade 7" reel unmarked
	C-3191	Automotive grade 13" reel unmarked
	C-7081	Commercial grade 7" reel unmarked
	C-7082	Commercial grade 13" reel unmarked

<sup>\* 2</sup> mm pitch reel only available for 0603 EIA case size. 2 mm pitch reel for 0805 EIA case size under development.

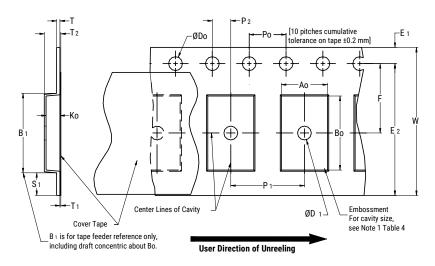
#### Benefits of Changing from 4 mm to 2 mm Pitching Spacing

- · Lower placement costs.
- Double the parts on each reel results in fewer reel changes and increased efficiency.
- Fewer reels result in lower packaging, shipping and storage costs, reducing waste.

<sup>\*</sup>Refer to Tables 6 and 7 for tolerance specifications.



## Figure 1 - Embossed (Plastic) Carrier Tape Dimensions



## **Table 6 – Embossed (Plastic) Carrier Tape Dimensions**

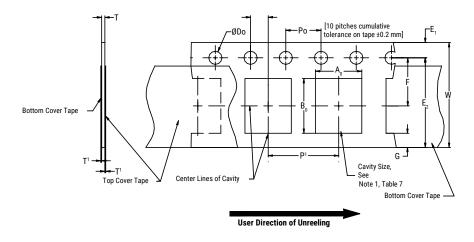
Metric will govern

	Constant Dimensions — Millimeters (Inches)											
Tape Size	D <sub>0</sub>	D <sub>1</sub> Minimum Note 1	E <sub>1</sub>	P <sub>0</sub>	P <sub>2</sub>	R Reference Note 2	S <sub>1</sub> Minimum Note 3	T Maximum	T <sub>1</sub> Maximum			
8 mm		1.0 (0.039)				25.0 (0.984)						
12 mm	1.5 +0.10/-0.0 (0.059 +0.004/-0.0)	1.5	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	30	0.600 (0.024)	0.600 (0.024)	0.100 (0.004)			
16 mm		(0.059)				(1.181)						
		,	Variable Dime	ensions — Mil	limeters (Inch	nes)						
Tape Size	Pitch	B <sub>1</sub> Maximum Note 4	E <sub>2</sub> Minimum	F	P <sub>1</sub>	T <sub>2</sub> Maximum	W Maximum	A <sub>0</sub> ,B <sub>0</sub>	& K <sub>0</sub>			
8 mm	Single (4 mm)	4.35 (0.171)	6.25 (0.246)	3.5 ±0.05 (0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	2.5 (0.098)	8.3 (0.327)					
12 mm	Single (4 mm) and Double (8 mm)	8.2 (0.323)	10.25 (0.404)	5.5 ±0.05 (0.217 ±0.002)	8.0 ±0.10 (0.315 ±0.004)	4.6 (0.181)	12.3 (0.484)	Not	e 5			
16 mm	Triple (12 mm)	12.1 (0.476)	14.25 (0.561)	7.5 ±0.05 (0.138 ±0.002)	12.0 ±0.10 (0.157 ±0.004)	4.6 (0.181)	16.3 (0.642)					

- 1. The embossment hole location shall be measured from the sprocket hole controlling the location of the embossment. Dimensions of embossment location and hole location shall be applied independent of each other.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).
- 3. If S, < 1.0 mm, there may not be enough area for cover tape to be properly applied (see EIA Standard 481 paragraph 4.3 section b).
- 4. B, dimension is a reference dimension for tape feeder clearance only.
- 5. The cavity defined by  $A_{o}$ ,  $B_{o}$  and  $K_{o}$  shall surround the component with sufficient clearance that:
  - (a) the component does not protrude above the top surface of the carrier tape.
  - (b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
  - (c) rotation of the component is limited to 20° maximum for 8 and 12 mm tapes and 10° maximum for 16 mm tapes (see Figure 3).
  - (d) lateral movement of the component is restricted to 0.5 mm maximum for 8 and 12 mm wide tape and to 1.0 mm maximum for 16 mm tape (see Figure 4).
  - (e) for KPS product,  $A_0$  and  $B_0$  are measured on a plane 0.3 mm above the bottom of the pocket.
  - (f) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.



## Figure 2 - Punched (Paper) Carrier Tape Dimensions



## **Table 7 - Punched (Paper) Carrier Tape Dimensions**

Metric will govern

	Constant Dimensions — Millimeters (Inches)											
Tape Size	D <sub>0</sub>	E <sub>1</sub>	P <sub>0</sub>	P <sub>2</sub>	T <sub>1</sub> Maximum	G Minimum	R Reference Note 2					
8 mm	1.5 +0.10 -0.0 (0.059 +0.004 -0.0)	1.75 ±0.10 (0.069 ±0.004)	4.0 ±0.10 (0.157 ±0.004)	2.0 ±0.05 (0.079 ±0.002)	0.10 (0.004) Maximum	0.75 (0.030)	25 (0.984)					
		Variable D	imensions – M	illimeters (Inch	es)							
Tape Size	Pitch	E2 Minimum	F	P <sub>1</sub>	T Maximum	W Maximum	$A_0B_0$					
8 mm	Half (2 mm)	6.25	3.5 ±0.05	2.0 ±0.05 (0.079 ±0.002)	1.1	8.3 (0.327)	Note 1					
8 mm	Single (4 mm)	(0.246)	(0.138 ±0.002)	4.0 ±0.10 (0.157 ±0.004)	(0.098)	8.3 (0.327)	Note 1					

- 1. The cavity defined by  $A_{n}$ ,  $B_{n}$  and T shall surround the component with sufficient clearance that:
  - a) the component does not protrude beyond either surface of the carrier tape.
  - b) the component can be removed from the cavity in a vertical direction without mechanical restriction, after the top cover tape has been removed.
  - c) rotation of the component is limited to 20° maximum (see Figure 3).
  - d) lateral movement of the component is restricted to 0.5 mm maximum (see Figure 4).
  - e) see addendum in EIA Standard 481 for standards relating to more precise taping requirements.
- 2. The tape with or without components shall pass around R without damage (see Figure 6).



## **Packaging Information Performance Notes**

1. Cover Tape Break Force: 1.0 kg minimum.

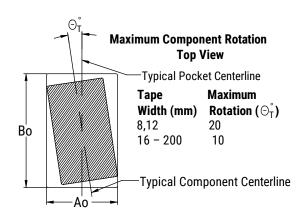
2. Cover Tape Peel Strength: The total peel strength of the cover tape from the carrier tape shall be:

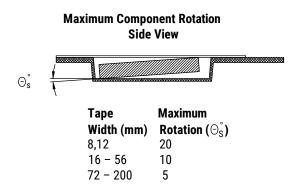
Tape Width	Peel Strength
8 mm	0.1 to 1.0 Newton (10 to 100 gf)
12 and 16 mm	0.1 to 1.3 Newton (10 to 130 gf)

The direction of the pull shall be opposite the direction of the carrier tape travel. The pull angle of the carrier tape shall be 165° to 180° from the plane of the carrier tape. During peeling, the carrier and/or cover tape shall be pulled at a velocity of 300 ±10 mm/minute.

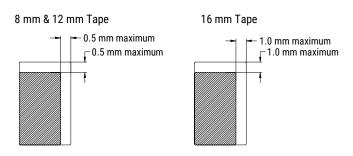
3. Labeling: Bar code labeling (standard or custom) shall be on the side of the reel opposite the sprocket holes. Refer to EIA Standards 556 and 624.

## **Figure 3 – Maximum Component Rotation**





## Figure 4 - Maximum Lateral Movement



# Figure 5 - Bending Radius

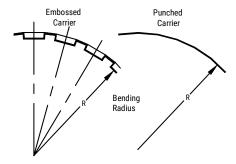
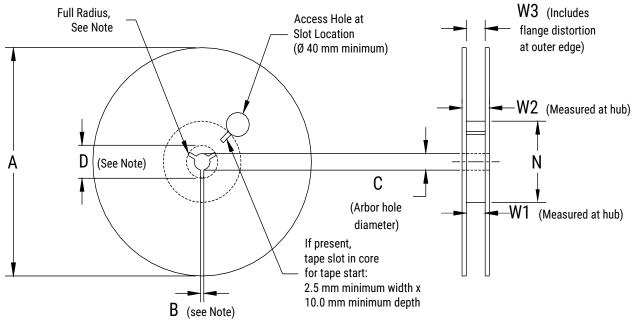




Figure 6 - Reel Dimensions



Note: Drive spokes optional; if used, dimensions B and D shall apply.

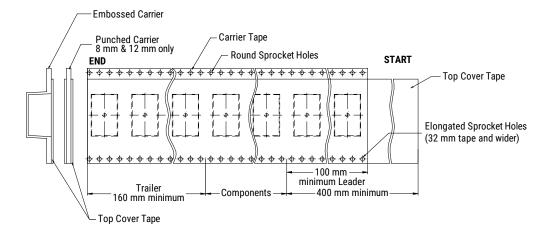
## **Table 8 - Reel Dimensions**

Metric will govern

	Constant	Dimensions — Millimete	rs (Inches)	
Tape Size	A	B Minimum	С	D Minimum
8 mm	178 ±0.20			
12 mm	(7.008 ±0.008) or	1.5 (0.059)	13.0 +0.5/-0.2 (0.521 +0.02/-0.008)	20.2 (0.795)
16 mm	330 ±0.20 (13.000 ±0.008)	, ,	,	, ,
	Variable	Dimensions — Millimeter	rs (Inches)	
Tape Size	N Minimum	W <sub>1</sub>	W <sub>2</sub> Maximum	W <sub>3</sub>
8 mm		8.4 +1.5/-0.0 (0.331 +0.059/-0.0)	14.4 (0.567)	
12 mm	50 (1.969)	12.4 +2.0/-0.0 (0.488 +0.078/-0.0)	18.4 (0.724)	Shall accommodate tape width without interference
16 mm		16.4 +2.0/-0.0 (0.646 +0.078/-0.0)	22.4 (0.882)	



## Figure 7 - Tape Leader & Trailer Dimensions



# Figure 8 – Maximum Camber





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